

Surface Mount Schottky Rectifiers

Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC





SMC (DO - 214AB)

Mechanical Date

- Case: JEDEC DO-214AB molded plastic body over glass passivated chip
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denotes cathode end

Major Ratings and Characteristics

I _{F(AV)}	8.0A
V _{RRM}	20 V to 100 V
I _{FSM}	200A
V _F	0.50V, 0.55, 0.70V, 0.85V
T _j max.	125 °C

Maximum Ratings & Thermal Characteristics

(T_A = 25 °C unless otherwise noted)

Items	Symbol	SK82	SK83	SK84	SK85	SK86	SK88	SK810	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	56	70	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	V
Maximum average forward rectified current	I _{F(AV)}	8.0					Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	200					Α		
Voltage rate of change (rated V _R)	dv/dt	10000				V/µs			
Thermal resistance from junction to lead ⁽¹⁾	$R_{\theta JL}$. 20				°C/W			
Operating junction and storage temperature range	T _J , T _{STG}	–65 to +125				$^{\circ}$			

Note 1: Mounted on P.C.B. with 0.55 × 0.55" (14×14 mm) copper pad areas.

Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Items	Test conditions		Symbol	SK82~83	SK84	SK85~86	SK88~810	UNIT	
Instantaneous forward voltage	I _F =8.0A ⁽²⁾		V_{F}	0.50 0.55		0.70	0.85	V	
Reverse current	V _R =V _{DC}	T _A =25℃	ı	1					
	V _R -V _{DC}	T _A =100℃	I _R		10		20	- mA	

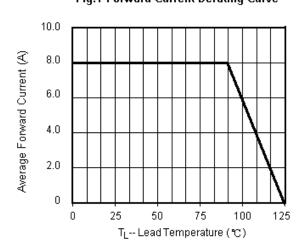
Note 2: Pulse test:300µs pulse width,1% duty cycle.



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Characteristic Curves (T_A=25 °C unless otherwise noted)

Fig.1 Forward Current Derating Curve



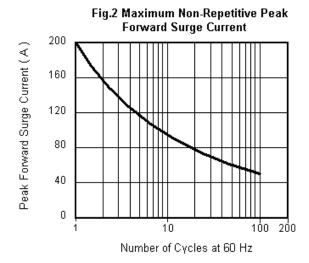
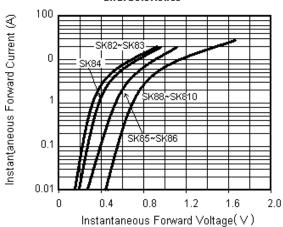
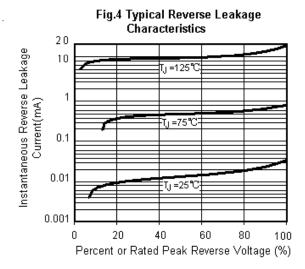


Fig.3 Typical Instantaneous Forward Characteristics

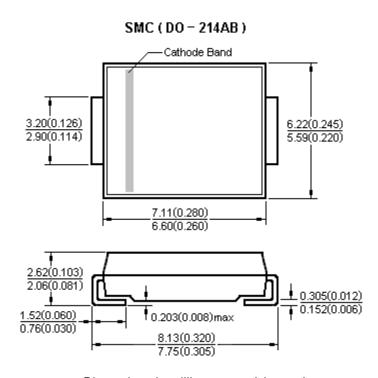






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Package Outline



Dimensions in millimeters and (inches)

Notice

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage.or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
 - $I_{\text{F(AV)}}\!:\!\text{We recommend}$ that the worst case current be no greater than 80% .
 - I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which the general during the lifespan of the device.
 - T_J : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_J of below 125°C.
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 specification to improve reliability, functional characteristics, or design without notice.
- Rising-sun Technology does not assure any liability arising out of the applications or any product described in this specification.
- Rising-sun Technology advises customers to obtain the latest version of the device information before placing orders to verify that the
 required information is current.